

# LX-1000 AOI

In-line large area optical inspection

Nordson YESTECH's advanced multi-purpose, large area, double-sided inspection system offers high speed PCB inspection with exceptional defect coverage. With dual sided top-down and bottom up viewing sensors, the LX-1000 inspects solder joints and verifies correct part assembly, enabling users to improve quality and enhance yields.

Advanced 2D and 3D sensors and newly available image processing technology integrates several techniques, including fringe projection, color inspection, normalized correlation and rule-based algorithms, to provide complete inspection metrology with an unmatched low false failure rate.

Programming the LX-1000 is fast and intuitive. Operators typically take less than 60 minutes to create a complete inspection program including solder inspection. The LX-1000 utilizes a standard package library to simplify training and ensure program portability across manufacturing lines.

The LX-1000 is highly effective for selective solder, post wave and connector inspections. Off-line programming maximizes machine utilization and real-time SPC monitoring provides a valuable yield enhancement solution.

#### Features:

- Single or dual sided imaging with full travel imaging sensors
- 630mm x 630mm large inspection area
- Optional 3D and/or 2D automated inspection
- Up to 100 mm clearance
- Heavy duty conveyor options for samples to 15kg
- High defect coverage / low false failure
- MES / Industry 4.0 compatible

#### **Automated Inspection for:**

- THT component and solder defects
- SMT component presence and position
- Wave / Selective solder joint inspection
- Correct part / polarity
- Configurable for automated conformal coat inspection (ACI)



## LX-1000 AOI Large Area Dual-Sided Optical inspection

### **Specifications**

Model

LX-1000

Multi-function system with top-down and bottom up

Up to 30 sq. in./sec. > 1.5 million components per hour

viewing with optional 3D inspection

**Specifications** 

Throughput:

630mm x 630mm)

Clearance:

Minimum Component Size:

False Calls:

Defects Detected:

Part: position, missing, wrong, polarity,

skew, tombstone

Lead: bent, lifted, bridging

Solder: open, insufficient, short, solder balls

**Software** 

Algorithms:

Data Requirements:

CAD Translation Package:

Programming Skill Level:

Operating System:

Off-line Software:

SPC Software:

Data Outputs:

**Hardware** 

Material Handling:

Lighting:

Imager:

**Facilities** 

Power: Air input:

Footprint:

Weight:

Machine Installation:

4" (100mm) top size and 2" (50mm) bottom

01005 with high magnification option

<500 PPM (<0.05% typical)

Color, OCV, OCR, barcode recognition, both image and

rule-based algorithms. Optional 3D

ASCII Text, X-Y position, part #, ref. #, polarity

Aegis, Fabmaster, YESTECH CAD Utility

Technician or operator

Windows 10

Optional - Rework, Review and Program Creation Basic

SPC included. Optional: Real-time local and remote

monitoring of first pass yield, defect trends, and

machine utilization.

Text, SQL, ODBC, MS Access, XML

SMEMA, dual direction auto width conveyor,

pass / fail signals, board clamping

Proprietary Fusion Lighting™ multiangle LED

Up to 15 megapixel color camera sensor

12 or 8 micron pixel size

110-220VAC, 50/60 Hz, 15 amps 60 PSI min., 1/4" air hose, 2 CFM

60" x 60" x 60" (2038mm x 1321mm x 1524mm)

950 lbs (500 kg)

< 1 hour

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